**Vishay Siliconix** 



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> (Max.) (nC)

Configuration

## **Power MOSFET**

S

N-Channel MOSFET

0.55

400

39

10

19

Single

 $V_{GS} = 10 V$ 

#### FEATURES

- Ultra low gate charge
- Reduced gate drive requirement
- Enhanced 30 V V<sub>GS</sub> rating
- Reduced C<sub>iss</sub>, C<sub>oss</sub>, C<sub>rss</sub>
- Extremely high frequency operation
- · Repetitive avalanche rated
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing the new LCDMOS technology, the device improvements are achieved without added product cost, allowing for reduced gate drive requirements and total system savings. In addition, reduced switching losses and improved efficiency are achievable in a variety of high frequency applications. Frequencies of a few MHz at high current are possible using the new Low Charge MOSFETs.

These device improvements combined with the proven ruggedness and reliability that are characteristic of Power MOSFETs ofter the designer a new standard in power transistors for switching applications.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF740LCPbF
Lead (Pb)-free and halogen-free	IRF740LCPbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS (T</b> C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	400	N	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1	10		
		T <sub>C</sub> = 100 °C	ID	6.3	A	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	32	1		
Linear derating factor			1.0	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	520	mJ		
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	10	A	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum power dissipation T <sub>C</sub> = 25 °C		PD	125	W		
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	- °C		
Soldering recommendations (peak temperature) <sup>d</sup> For 10 s			300 <sup>d</sup>			
Mounting torque	6-32 or M3 screw			10	lbf · in	
Mounting torque				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 9.1 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 10 \text{ A}$  (see fig. 12)

c.  $I_{SD} \le 10$  A,  $dI/dt \le 120$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.0	

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	unless otherw	rise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	400	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	to 25 °C, I <sub>D</sub> = 1 mA	-	0.76	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{CS}$	<sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	lass	$V_{DS} = 40$	00 V, V <sub>GS</sub> = 0 V	-	-	25	
	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V, V	$V_{DS} = 320 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 6.0 A <sup>b</sup>	-	-	0.55	Ω
Forward transconductance	9 <sub>fs</sub>	$V_{DS} = 5$	0 V, I <sub>D</sub> = 6.0 A <sup>b</sup>	3.0	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V	<sub>GS</sub> = 0 V,	-	1100	-	
Output capacitance	C <sub>oss</sub>	V	<sub>DS</sub> = 25 V,	-	190	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5 - 18 -		-			
Total gate charge	Qg			-	-	39	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, V <sub>DS</sub> = 320 V see fig. 6 and 13 <sup>b</sup>	-	-	10	nC
Gate-drain charge	Q <sub>gd</sub>		<b>3 1 1 1</b>	-	-	19	
Turn-on delay time	t <sub>d(on)</sub>			-	11	-	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 20	00 V, I <sub>D</sub> = 10 A ,	-	31	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 9.1 \Omega, R_f$	$_{\rm D}$ = 20 $\Omega$ , see fig. 10 <sup>b</sup>	-	25	-	ns
Fall time	t <sub>f</sub>	-		-	20	-	1
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal source inductance	Ls			-	7.5	-	
Drain-Source Body Diode Characteristic	cs	4			<u> </u>	<u> </u>	<u>.</u>
Continuous source-drain diode current	I <sub>S</sub>	MOSFET sym showing the	e (	-	-	10	_
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	p - n junction diode		-	-	32	A
Body diode voltage	V <sub>SD</sub>	$T_J = 25 \ ^{\circ}C, I_S = 10 \ A, V_{GS} = 0 \ V^b$		-	-	2.0	V
Body diode reverse recovery time	t <sub>rr</sub>	T - 25 °C I	10 A dl/dt - 100 A /	-	380	570	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_{\rm J} = 25^{-1} O, I_{\rm F} =$	10 A, dl/dt = 100 A/µs <sup>b</sup>	-	2.8	4.2	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn	-on time is negligible (turn	-on is do	minated b	by L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

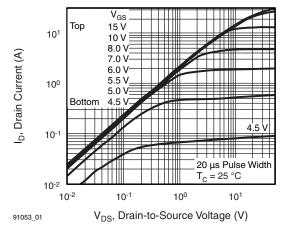


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

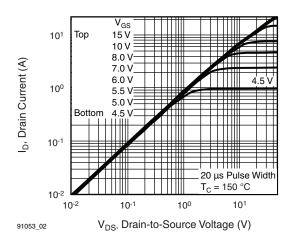


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

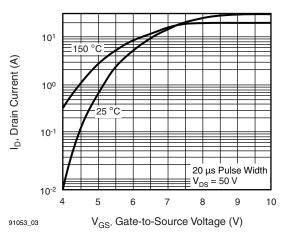


Fig. 2 - Typical Transfer Characteristics

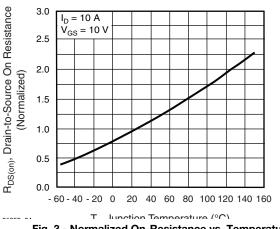


Fig. 3 - Normalized On-Resistance vs. Temperature

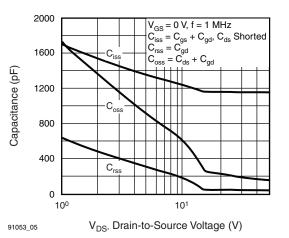


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

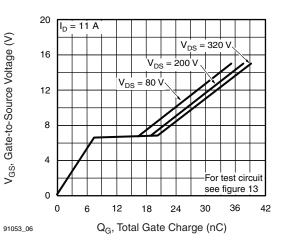


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

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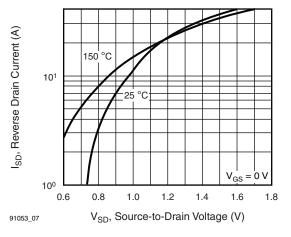


Fig. 6 - Typical Source-Drain Diode Forward Voltage

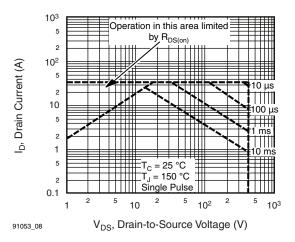


Fig. 7 - Maximum Safe Operating Area

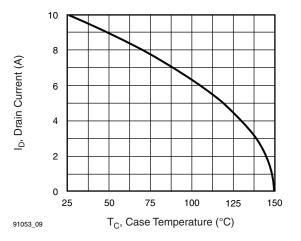


Fig. 9 - Maximum Drain Current vs. Case Temperature

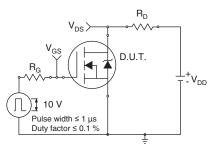


Fig. 10a - Switching Time Test Circuit

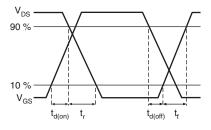


Fig. 10b - Switching Time Waveforms

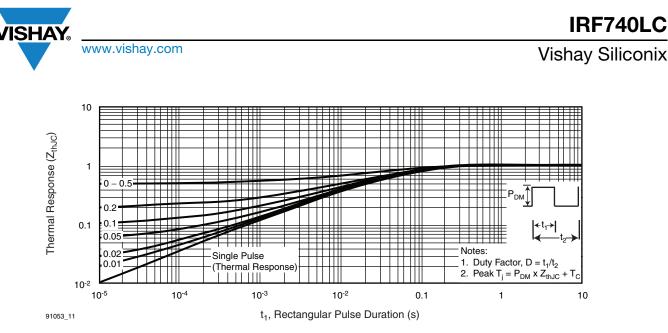


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

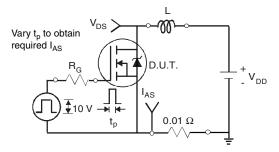


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

V<sub>DS</sub>

 $I_{AS}$ 

/<sub>DS</sub>

 $V_{DD}$ 

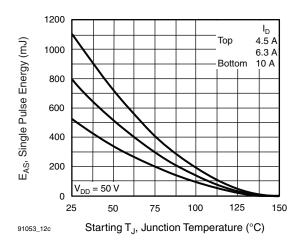
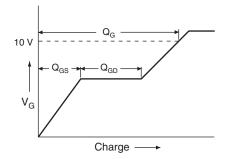


Fig. 12c - Maximum Avalanche Energy vs. Drain Current



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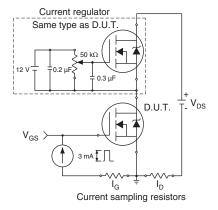
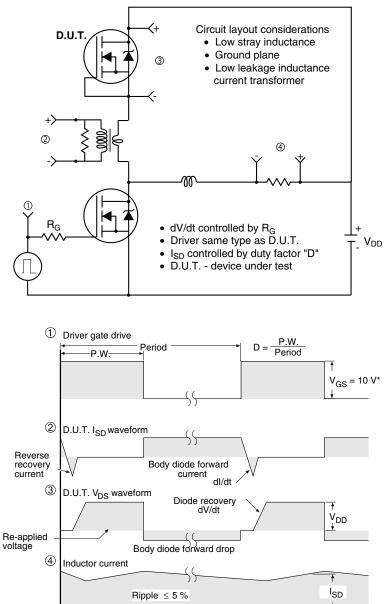


Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit



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#### Peak Diode Recovery dV/dt Test Circuit

\*  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

#### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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